



SPECIFICATION

(Reference sheet)

· Supplier : Samsung electro-mechanics · Samsung P/N : CL21B335KPFNNNE

Product : Multi-layer Ceramic Capacitor

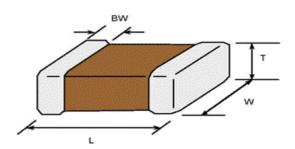
Description : CAP, 3.3uF, 10V, ±10%, X7R, 0805

A. Samsung Part Number

<u>CL</u> <u>21</u> <u>B</u> <u>335</u> <u>K</u> <u>P</u> <u>F</u> <u>N</u> <u>N</u> <u>N</u> <u>E</u> ① ② ③ ④ ⑤ ⑥ ⑦ ⑧ ⑨ ⑩ ⑪

1	Series	Samsung Multi-layer Ceramic Capacitor					
2	Size	0805 (inch code)	L: 2.00 ± 0.10 mm		W:	$1.25 \pm 0.10 \text{ mm}$	
3	Dielectric	X7R	8	Inner electrode		Ni	
4	Capacitance	3.3 uF		Termination		Cu	
(5)	Capacitance	±10 %		Plating		Sn 100% (Pb Free)	
	tolerance		9	Product		Normal	
6	Rated Voltage	10 V	10	Special		Reserved for future use	
7	Thickness	$1.25 \pm 0.10 \text{ mm}$	11)	Packaging		Embossed Type, 7" reel	

B. Structure & Dimension



Samsung P/N	Dimension(mm)					
Samsung F/N	L	W	Т	BW		
CL21B335KPFNNNE	2.00 ± 0.10	1.25 ± 0.10	1.25 ± 0.10	0.50 +0.20/-0.30		

C. Samsung Reliablility Test and Judgement Condition

Capacitance Within specified tolerance	kHz ±10% / 1.0±0.2Vrms			
	1 ^{kHz} ±10% / 1.0±0.2Vrms			
Tan δ (DF) 0.1 max. treation	A capacitor prior to measuring the capacitance is heat reated at $150^{\circ}\text{C} + 0/-10^{\circ}\text{C}$ for 1 hour and maintained in mbient air for 24 ± 2 hours.			
Insulation 10,000Mohm or 100Mohm× <i>μ</i> F R	Rated Voltage 60~120 sec.			
Resistance Whichever is smaller				
Appearance No abnormal exterior appearance M	flicroscope (×10)			
Withstanding No dielectric breakdown or	250% of the rated voltage			
Voltage mechanical breakdown	-			
Temperature X7R				
Characteristics (From-55 °C to 125 °C, Capacitance change sho	ould be within ±15%)			
	00g·f, for 10±1 sec.			
of Termination terminal electrode				
Bending Strength Capacitance change: within ±12.5% B	Bending to the limit (1mm)			
l w	with 1.0mm/sec.			
Solderability More than 75% of terminal surface S	SnAg3.0Cu0.5 solder			
	45±5°C, 3±0.3sec.			
· ·	oreheating : 80~120°C for 10~30sec.)			
Resistance to Capacitance change: within ±7.5% So	Solder pot : 270±5℃, 10±1sec.			
Soldering Heat Tan δ, IR : initial spec.				
Tan δ, IR : initial spec.	Implitude: 1.5mm From 10Hz to 55Hz (return: 1min.) Flours × 3 direction (x, y, z)			
Moisture Capacitance change: within ±12.5% W	Vith rated voltage			
Resistance Tan δ: 0.125 max 46	0±2°C, 90~95%RH, 500+12/-0hrs			
IR: 500Mohm or 12.5Mohm × μ F				
Whichever is smaller				
High Temperature Capacitance change: within ±12.5% W	Vith 150% of the rated voltage			
Resistance Tan δ: 0.125 max M	Max. operating temperature			
	000+48/-0hrs			
Whichever is smaller				
Temperature Capacitance change: within ±7.5% 1	cycle condition			
1 '	/in. operating temperature → 25°C			
	→ Max. operating temperature → 25°C			
5	cycle test			

X The reliability test condition can be replaced by the corresponding accelerated test condition.

D. Recommended Soldering method:

Reflow (Reflow Peak Temperature : 260+0/-5°C, 10sec. Max)



A Product specifications included in the specifications are effective as of March 1, 2013.

Please be advised that they are standard product specifications for reference only.

We may change, modify or discontinue the product specifications without notice at any time.

So, you need to approve the product specifications before placing an order.

Should you have any question regarding the product specifications,

please contact our sales personnel or application engineers.

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The products listed in this Specification sheet are **NOT** designed and manufactured for any use and applications set forth below.

Please note that any misuse of the products deviating from products specifications or information provided in this Spec sheet may cause serious property damages or personal injury.

We will **NOT** be liable for any damages resulting from any misuse of the products, specifically including using the products for high reliability applications as listed below.

If you have any questions regarding this 'Limitation of Use and Application', you should first contact our sales personnel or application engineers.

- ① Aerospace/Aviation equipment
- 2 Automotive or Transportation equipment (vehicles, trains, ships, etc)
- 3 Medical equipment
- 4 Military equipment
- ⑤ Disaster prevention/crime prevention equipment
- 6 Power plant control equipment
- Atomic energy-related equipment
- Undersea equipment
- Traffic signal equipment
- Data-processing equipment
- ## Electric heating apparatus, burning equipment
- Safety equipment
- ® Any other applications with the same as or similar complexity or reliability to the applications